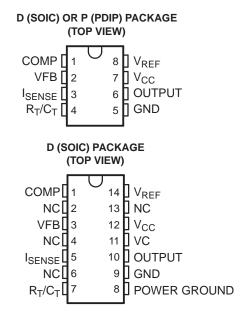
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### **FEATURES**

- Low Start-Up Current (<0.5 mA)</li>
- Trimmed Oscillator Discharge Current
- Current Mode Operation to 500 kHz
- Automatic Feed-Forward Compensation
- Latching PWM for Cycle-by-Cycle Current Limiting
- Internally Trimmed Reference With Undervoltage Lockout
- High-Current Totem-Pole Output Undervoltage Lockout With Hysteresis
- Double-Pulse Suppression



NC - No internal connection

### **DESCRIPTION/ORDERING INFORMATION**

The TL284xB and TL384xB series of control integrated circuits provide the features that are necessary to implement off-line or dc-to-dc fixed-frequency current-mode control schemes, with a minimum number of external components. Internally implemented circuits include an undervoltage lockout (UVLO) and a precision reference that is trimmed for accuracy at the error amplifier input. Other internal circuits include logic to ensure latched operation, a pulse-width modulation (PWM) comparator that also provides current-limit control, and a totem-pole output stage designed to source or sink high-peak current. The output stage, suitable for driving N-channel MOSFETs, is low when it is in the off state.

The TL284xB and TL384xB series are pin compatible with the standard TL284x and TL384x with the following improvements. The start-up current is specified to be 0.5 mA (max), while the oscillator discharge current is trimmed to 8.3 mA (typ). In addition, during undervoltage lockout conditions, the output has a maximum saturation voltage of 1.2 V while sinking 10 mA ( $V_{CC} = 5 \text{ V}$ ).

Major differences between members of these series are the UVLO thresholds and maximum duty-cycle ranges. Typical UVLO thresholds of 16 V (on) and 10 V (off) on the TLx842B and TLx844B devices make them ideally suited to off-line applications. The corresponding typical thresholds for the TLx843B and TLx845B devices are 8.4 V (on) and 7.6 V (off). The TLx842B and TLx843B devices can operate to duty cycles approaching 100%. A duty-cycle range of 0% to 50% is obtained by the TLx844B and TLx845B by the addition of an internal toggle flip-flop, which blanks the output off every other clock cycle. The TL284xB-series devices are characterized for operation from  $-40^{\circ}$ C to  $85^{\circ}$ C. The TL384xB-series devices are characterized for operation from  $0^{\circ}$ C to  $70^{\circ}$ C.



Please be aware that an important notice concerning availability, standard warranty, and use in critical applications of Texas Instruments semiconductor products and disclaimers thereto appears at the end of this data sheet.

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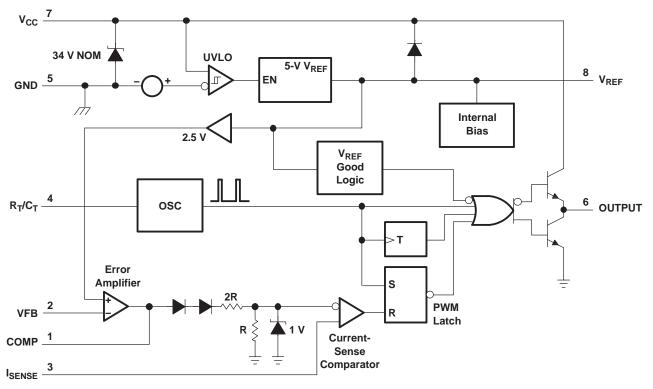
### **ORDERING INFORMATION**

| T <sub>A</sub> | PAC                | CKAGE <sup>(1)</sup> | ORDERABLE PART NUMBER | TOP-SIDE MARKING |
|----------------|--------------------|----------------------|-----------------------|------------------|
|                |                    |                      | TL2842BP              | TL2842BP         |
|                | PDIP – P           | Tube of 50           | TL2843BP              | TL2843BP         |
|                | PDIP = P           | Tube of 50           | TL2844BP              | TL2844BP         |
|                |                    |                      | TL2845BP              | TL2845BP         |
|                |                    | Tube of 75           | TL2842BD-8            | 2042D            |
|                |                    | Reel of 2500         | TL2842BDR-8           | 2842B            |
|                |                    | Tube of 75           | TL2843BD-8            | - 2843B          |
|                | COIC D (0 nin)     | Reel of 2500         | TL2843BDR-8           | 2043D            |
|                | SOIC – D (8 pin)   | Tube of 75           | TL2844BD-8            | 2044D            |
| 40°C to 95°C   |                    | Reel of 2500         | TL2844BDR-8           | 2844B            |
| –40°C to 85°C  |                    | Tube of 75           | TL2845BD-8            | 204ED            |
|                |                    | Reel of 2500         | TL2845BDR-8           | 2845B            |
|                |                    | Tube of 75           | TL2842BD              | TI 2042D         |
|                |                    | Reel of 2500         | TL2842BDR             | TL2842B          |
|                |                    | Tube of 75           | TL2843BD              | TI 2042D         |
|                | SOIC – D (14 pin)  | Reel of 2500         | TL2843BDR             | TL2843B          |
|                | 3010 - D (14 pill) | Tube of 75           | TL2844BD              | TL2844B          |
|                |                    | Reel of 2500         | TL2844BDR             | 1L2044D          |
|                |                    | Tube of 75           | TL2845BD              | TI 2045D         |
|                |                    | Reel of 2500         | TL2845BDR             | TL2845B          |
|                |                    |                      | TL3842BP              | TL3842BP         |
|                | PDIP – P           | Tube of 50           | TL3843BP              | TL3843BP         |
|                | 1 011 -1           | Tube of 30           | TL3844BP              | TL3844BP         |
|                |                    |                      | TL3845BP              | TL3845BP         |
|                |                    | Tube of 75           | TL3842BD-8            | 3842B            |
|                |                    | Reel of 2500         | TL3842BDR-8           | 304215           |
|                |                    | Tube of 75           | TL3843BD-8            | 3843B            |
|                | SOIC – D (8 pin)   | Reel of 2500         | TL3843BDR-8           | 3043D            |
|                | 3010 - D (0 pin)   | Tube of 75           | TL3844BD-8            | 3844B            |
| 0°C to 70°C    |                    | Reel of 2500         | TL3844BDR-8           | 30440            |
| 0 0 10 70 0    |                    | Tube of 75           | TL3845BD-8            | 3845B            |
|                |                    | Reel of 2500         | TL3845BDR-8           | 30435            |
|                |                    | Tube of 75           | TL3842BD              | TL3842B          |
|                |                    | Reel of 2500         | TL3842BDR             | LUUTED           |
|                |                    | Tube of 75           | TL3843BD              | TL3843B          |
|                | SOIC – D (14 pin)  | Reel of 2500         | TL3843BDR             | . 230 105        |
|                | 2010 D (14 pin)    | Tube of 75           | TL3844BD              | TL3844B          |
|                |                    | Reel of 2500         | TL3844BDR             | . 250 1 15       |
|                |                    | Tube of 75           | TL3845BD              | TL3845B          |
|                |                    | Reel of 2500         | TL3845BDR             | 1230705          |

<sup>(1)</sup> Package drawings, standard packing quantities, thermal data, symbolization, and PCB design guidelines are available at www.ti.com/sc/package.

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### **FUNCTIONAL BLOCK DIAGRAM**



A. Pin numbers shown are for the 8-pin D package.

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# **Absolute Maximum Ratings**(1)(2)

over operating free-air temperature range (unless otherwise noted)

|                      |                                     |                            |        | MIN  | MAX              | UNIT |
|----------------------|-------------------------------------|----------------------------|--------|------|------------------|------|
|                      |                                     | Low impedance so           | urce   |      | 30               |      |
| V <sub>CC</sub>      | Supply voltage                      | I <sub>CC</sub> < 30 mA    |        |      | Self<br>limiting | V    |
| VI                   | Analog input voltage range          | VFB and I <sub>SENSE</sub> |        | -0.3 | 6.3              | V    |
| I <sub>CC</sub>      | Supply current                      |                            |        |      | 30               | mA   |
| Io                   | Output current                      |                            |        |      | ±1               | Α    |
| I <sub>O(sink)</sub> | Error amplifier output sink current |                            |        |      | 10               | mA   |
|                      |                                     | Dinaskaga                  | 8 pin  |      | 97               |      |
| $\theta_{JA}$        | Package thermal impedance (3)(4)    | D package                  | 14 pin |      | 86               | °C/W |
|                      |                                     | P package                  |        |      | 85               |      |
|                      | Output energy                       | Capacitive load            |        |      | 5                | μJ   |
| TJ                   | Virtual junction temperature        |                            |        |      | 150              | °C   |
| T <sub>stg</sub>     | Storage temperature range           |                            |        | -65  | 150              | °C   |
| T <sub>lead</sub>    | Lead temperature                    | Soldering, 10 s            |        |      | 300              | °C   |

<sup>(1)</sup> Stresses beyond those listed under "absolute maximum ratings" may cause permanent damage to the device. These are stress ratings only, and functional operation of the device at these or any other conditions beyond those indicated under "recommended operating conditions" is not implied. Exposure to absolute-maximum-rated conditions for extended periods may affect device reliability.

(2) All voltages are with respect to the device GND terminal.

# **Recommended Operating Conditions**

|                     |                                    |                                | MIN  | NOM | MAX | UNIT |
|---------------------|------------------------------------|--------------------------------|------|-----|-----|------|
| \/                  | Cumphy valtage                     | V <sub>CC</sub>                |      |     | 30  | ٧    |
| V <sub>CC</sub>     | Supply voltage                     | VC <sup>(1)</sup>              |      |     | 30  | V    |
| \/                  | lanut valtaga                      | R <sub>T</sub> /C <sub>T</sub> | 0    |     | 5.5 | V    |
| VI                  | Input voltage                      | VFB and I <sub>SENSE</sub>     | 0    |     | 5.5 | V    |
| \/                  | Output valtage                     | OUTPUT                         | 0    |     | 30  | V    |
| Vo                  | Output voltage                     | POWER GROUND <sup>(1)</sup>    | -0.1 |     | 1   | V    |
| I <sub>CC</sub>     | Supply current, externally limited |                                |      |     | 25  | mA   |
| Io                  | Average output current             |                                |      |     | 200 | mA   |
| I <sub>O(ref)</sub> | Reference output current           |                                |      |     | -20 | mA   |
| f <sub>osc</sub>    | Oscillator frequency               |                                |      | 100 | 500 | kHz  |
| т                   | Operating free-air temperature     | TL284xB                        | -40  |     | 85  | °C   |
| $T_J$               | Operating nee-all temperature      | TL384xB                        | 0    |     | 70  | C    |

<sup>(1)</sup> The recommended voltages for VC and POWER GROUND apply only to the 14-pin D package.

<sup>(3)</sup> Maximum power dissipation is a function of  $T_J(max)$ ,  $\theta_{JA}$ , and  $T_A$ . The maximum allowable power dissipation at any allowable ambient temperature is  $P_D = (T_J(max) - T_A)/\theta_{JA}$ . Operating at the absolute maximum  $T_J$  of 150°C can impact reliability.

<sup>(4)</sup> The package thermal impedance is calculated in accordance with JESD 51-7.



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# **Reference Section Electrical Characteristics**

 $V_{CC}$  = 15  $V^{(1)}$ ,  $R_T$  = 10  $k\Omega$ ,  $C_T$  = 3.3 nF, over recommended operating free-air temperature range (unless otherwise specified)

| DADAMETED   | TEST COMPLETIONS  |      | TL284xB            |      | •    | TL384xB            |      | LINUT |
|---|---|------|--------------------|------|------|--------------------|------|-------|
| PARAMETER   | TEST CONDITIONS   | MIN  | TYP <sup>(2)</sup> | MAX  | MIN  | TYP <sup>(2)</sup> | MAX  | UNIT  |
| Output voltage                                    | I <sub>O</sub> = 1 mA, T <sub>J</sub> = 25°C  | 4.95 | 5                  | 5.05 | 4.9  | 5                  | 5.1  | V     |
| Line regulation                                   | V <sub>CC</sub> = 12 V to 25 V  |      | 6                  | 20   |      | 6                  | 20   | mV    |
| Load regulation                                   | $I_O = 1$ mA to 20 mA   |      | 6                  | 25   |      | 6                  | 25   | mV    |
| Average temperature coefficient of output voltage |   |      | 0.2                | 0.4  |      | 0.2                | 0.4  | mV/°C |
| Output voltage, worst-case variation              | $V_{CC} = 12 \text{ V to } 25 \text{ V},$<br>$I_{O} = 1 \text{ mA to } 20 \text{ mA}$ | 4.9  |                    | 5.1  | 4.82 |                    | 5.18 | ٧     |
| Output noise voltage                              | $f = 10 \text{ Hz to } 10 \text{ kHz}, T_J = 25^{\circ}\text{C}$                      |      | 50                 |      |      | 50                 |      | μV    |
| Output-voltage long-term drift                    | After 1000 h at T <sub>J</sub> = 25°C   |      | 5                  | 25   |      | 5                  | 25   | mV    |
| Short-circuit output current                      |   | -30  | -100               | -180 | -30  | -100               | -180 | mA    |

<sup>(1)</sup> Adjust  $V_{CC}$  above the start threshold before setting it to 15 V.

# Oscillator Section<sup>(1)</sup> Electrical Characteristics

 $V_{CC}$  = 15  $V^{(2)}$ ,  $R_T$  = 10  $k\Omega$ ,  $C_T$  = 3.3 nF, over recommended operating free-air temperature range (unless otherwise specified)

| DADAMETED             | TEST CONDITIONS  |     | TL284xB            |     |     | TL384xB            |     | LINIT |
|-----------------------|--|-----|--------------------|-----|-----|--------------------|-----|-------|
| PARAMETER             | TEST CONDITIONS  | MIN | TYP <sup>(3)</sup> | MAX | MIN | TYP <sup>(3)</sup> | MAX | UNIT  |
|                       | T <sub>J</sub> = 25°C  | 49  | 52                 | 55  | 49  | 52                 | 55  |       |
| Initial accuracy      | $T_A = T_{low}$ to $T_{high}$  | 48  |                    | 56  | 48  |                    | 56  | kHz   |
| ililiai accuracy      | $T_J = 25^{\circ}C$ , $R_T = 6.2 \text{ k}\Omega$ , $C_T = 1 \text{ nF}$ | 225 | 250                | 275 | 225 | 250                | 275 | 11.12 |
| Voltage stability     | V <sub>CC</sub> = 12 V to 25 V   |     | 0.2                | 1   |     | 0.2                | 1   | %     |
| Temperature stability |  |     | 5                  |     |     | 5                  |     | %     |
| Amplitude             | Peak to peak   |     | 1.7                |     |     | 1.7                |     | V     |
| Diagharga gurrant     | $T_J = 25^{\circ}C, R_T/C_T = 2 V$                                       | 7.8 | 8.3                | 8.8 | 7.8 | 8.3                | 8.8 | A     |
| Discharge current     | $R_T/C_T = 2 V$  | 7.5 |                    | 8.8 | 7.6 |                    | 8.8 | mA    |

<sup>(1)</sup> Output frequency equals oscillator frequency for the TL3842B and TL3843B. Output frequency is one-half the oscillator frequency for the TL3844B and TL3845B.

<sup>(2)</sup> All typical values are at  $T_J = 25$ °C.

<sup>(2)</sup> Adjust  $V_{CC}$  above the start threshold before setting it to 15 V.

<sup>(3)</sup> All typical values are at  $T_J = 25$ °C.

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# **Error-Amplifier Section Electrical Characteristics**

 $V_{CC}$  = 15  $V^{(1)}$ ,  $R_T$  = 10  $k\Omega$ ,  $C_T$  = 3.3 nF, over recommended operating free-air temperature range (unless otherwise specified)

| DADAMETED                       | TEST CONDITIONS                               |      | TL284xB            |      |      | TL384xB            |      | LINUT |
|---------------------------------|---|------|--------------------|------|------|--------------------|------|-------|
| PARAMETER                       | TEST CONDITIONS                               | MIN  | TYP <sup>(2)</sup> | MAX  | MIN  | TYP <sup>(2)</sup> | MAX  | UNIT  |
| Feedback input voltage          | COMP = 2.5 V                                  | 2.45 | 2.5                | 2.55 | 2.42 | 2.5                | 2.58 | V     |
| Input bias current              |   |      | -0.3               | -1   |      | -0.3               | -2   | μΑ    |
| Open-loop voltage amplification | V <sub>O</sub> = 2 V to 4 V                   | 65   | 90                 |      | 65   | 90                 |      | dB    |
| Gain-bandwidth product          |   | 0.7  | 1                  |      | 0.7  | 1                  |      | MHz   |
| Supply-voltage rejection ratio  | V <sub>CC</sub> = 12 V to 25 V                | 60   | 70                 |      | 60   | 70                 |      | dB    |
| Output sink current             | VFB = 2.7 V, COMP = 1.1 V                     | 2    | 6                  |      | 2    | 6                  |      | mA    |
| Output source current           | VFB = 2.3 V, COMP = 5 V                       | -0.5 | -0.8               |      | -0.5 | -0.8               |      | mA    |
| High-level output voltage       | VFB = 2.3 V,<br>R <sub>L</sub> = 15 kΩ to GND | 5    | 6                  |      | 5    | 6                  |      | V     |
| Low-level output voltage        | VFB = 2.7 V,<br>R <sub>L</sub> = 15 kΩ to GND |      | 0.7                | 1.1  |      | 0.7                | 1.1  | V     |

<sup>(1)</sup> Adjust  $V_{CC}$  above the start threshold before setting it to 15 V. (2) All typical values are at  $T_J=25^{\circ}C$ .

### **Current-Sense Section Electrical Characteristics**

 $V_{CC} = 15 \text{ V}^{(1)}, R_T = 10 \text{ k}\Omega, C_T = 3.3 \text{ nF}, \text{ over recommended operating free-air temperature range (unless otherwise specified)}$ 

| DADAMETED                              | TEST COMPITIONS                |      | TL284xB            |      |      | TL384xB            |      | LINUT |
|--|--------------------------------|------|--------------------|------|------|--------------------|------|-------|
| PARAMETER                              | TEST CONDITIONS                | MIN  | TYP <sup>(2)</sup> | MAX  | MIN  | TYP <sup>(2)</sup> | MAX  | UNIT  |
| Voltage amplification (3)(4)           |                                | 2.85 | 3                  | 3.15 | 2.85 | 3                  | 3.15 | V/V   |
| Current-sense comparator threshold (3) | COMP = 5 V                     | 0.9  | 1                  | 1.1  | 0.9  | 1                  | 1.1  | V     |
| Supply-voltage rejection ratio (3)     | V <sub>CC</sub> = 12 V to 25 V |      | 70                 |      |      | 70                 |      | dB    |
| Input bias current                     |                                |      | -2                 | -10  |      | -2                 | -10  | μA    |
| Delay time to output                   | VFB = 0 V to 2 V               |      | 150                | 300  |      | 150                | 300  | ns    |

<sup>(1)</sup> Adjust  $V_{CC}$  above the start threshold before setting it to 15 V.

<sup>(2)</sup> All typical values are at T<sub>J</sub> = 25°C.

<sup>(3)</sup> Measured at the trip point of the latch, with VFB at 0 V.

<sup>(4)</sup> Measured between I<sub>SENSE</sub> and COMP, with the input changing from 0 V to 0.8 V.



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# **Output Section Electrical Characteristics**

 $V_{CC} = 15 \text{ V}^{(1)}$ ,  $R_T = 10 \text{ k}\Omega$ ,  $C_T = 3.3 \text{ nF}$ , over recommended operating free-air temperature range (unless otherwise specified)

| PARAMETER                 | TEST CONDITIONS                               |     | TL284xB            |     |     | TL384xB            |     | UNIT |
|---------------------------|---|-----|--------------------|-----|-----|--------------------|-----|------|
| PARAWETER                 | TEST CONDITIONS                               | MIN | TYP <sup>(2)</sup> | MAX | MIN | TYP <sup>(2)</sup> | MAX | UNII |
| High lovel output voltage | I <sub>OH</sub> = -20 mA                      | 13  | 13.5               |     | 13  | 13.5               |     | V    |
| High-level output voltage | $I_{OH} = -200 \text{ mA}$                    | 12  | 13.5               |     | 12  | 13.5               |     | V    |
| Low-level output voltage  | I <sub>OL</sub> = 20 mA                       |     | 0.1                | 0.4 |     | 0.1                | 0.4 | V    |
| Low-level output voltage  | I <sub>OL</sub> = 200 mA                      |     | 1.5                | 2.2 |     | 1.5                | 2.2 | V    |
| Rise time                 | $C_L = 1 \text{ nF, } T_J = 25^{\circ}C$      |     | 50                 | 150 |     | 50                 | 150 | ns   |
| Fall time                 | $C_L = 1 \text{ nF, } T_J = 25^{\circ}C$      |     | 50                 | 150 |     | 50                 | 150 | ns   |
| UVLO saturation           | V <sub>CC</sub> = 5 V, I <sub>OL</sub> = 1 mA |     | 0.7                | 1.2 |     | 0.7                | 1.2 | V    |

<sup>(1)</sup> Adjust V<sub>CC</sub> above the start threshold before setting it to 15 V.

# **Undervoltage-Lockout Section Electrical Characteristics**

 $V_{CC} = 15 \text{ V}^{(1)}$ ,  $R_T = 10 \text{ k}\Omega$ ,  $C_T = 3.3 \text{ nF}$ , over recommended operating free-air temperature range (unless otherwise specified)

| DADAMETED                 | TEST CONDITIONS  |     | TL284xB            |     |      |                    | LINUT |      |
|---------------------------|------------------|-----|--------------------|-----|------|--------------------|-------|------|
| PARAMETER                 | TEST CONDITIONS  | MIN | TYP <sup>(2)</sup> | MAX | MIN  | TYP <sup>(2)</sup> | MAX   | UNIT |
| Start threshold voltage   | TLx842B, TLx844B | 15  | 16                 | 17  | 14.5 | 16                 | 17.5  | V    |
| Start tilleshold voltage  | TLx843B, TLx845B | 7.8 | 8.4                | 9   | 7.8  | 8.4                | 9     | V    |
| Minimum operating voltage | TLx842B, TLx844B | 9   | 10                 | 11  | 8.5  | 10                 | 11.5  | \/   |
| after start-up            | TLx843B, TLx845B | 7   | 7.6                | 8.2 | 7    | 7.6                | 8.2   | V    |

<sup>(1)</sup> Adjust  $V_{CC}$  above the start threshold before setting it to 15 V.

### **Pulse-Width Modulator Section Electrical Characteristics**

 $V_{CC}$  = 15  $V^{(1)}$ ,  $R_T$  = 10  $k\Omega$ ,  $C_T$  = 3.3 nF, over recommended operating free-air temperature range (unless otherwise specified)

| PARAMETER          | TEST CONDITIONS  | •   | TL284xB            |     | TL384xB |                    |     | UNIT |
|--------------------|------------------|-----|--------------------|-----|---------|--------------------|-----|------|
| PARAMETER          | TEST CONDITIONS  | MIN | TYP <sup>(2)</sup> | MAX | MIN     | TYP <sup>(2)</sup> | MAX | UNII |
| Maximum duty avala | TL3842B, TL3843B | 94  | 96                 | 100 | 94      | 96                 | 100 | %    |
| Maximum duty cycle | TL3844B, TL3845B | 47  | 48                 | 50  | 47      | 48                 | 50  | 70   |
| Minimum duty cycle |                  |     |                    | 0   |         |                    | 0   | %    |

<sup>(1)</sup> Adjust  $V_{CC}$  above the start threshold before setting it to 15 V.

### **Supply Voltage Electrical Characteristics**

 $V_{CC}$  = 15  $V^{(1)}$ ,  $R_T$  = 10  $k\Omega$ ,  $C_T$  = 3.3 nF, over recommended operating free-air temperature range (unless otherwise specified)

| PARAMETER                | TEST CONDITIONS                   |     | TL284xB            |     | •   | TL384xB            |     |      |
|--------------------------|-----------------------------------|-----|--------------------|-----|-----|--------------------|-----|------|
| PARAMETER                | TEST CONDITIONS                   | MIN | TYP <sup>(2)</sup> | MAX | MIN | TYP <sup>(2)</sup> | MAX | UNIT |
| Start-up current         |                                   |     | 0.3                | 0.5 |     | 0.3                | 0.5 | mA   |
| Operating supply current | VFB and I <sub>SENSE</sub> at 0 V |     | 11                 | 17  |     | 11                 | 17  | mA   |
| Limiting voltage         | I <sub>CC</sub> = 25 mA           | 30  | 34                 |     | 30  | 34                 |     | V    |

<sup>(1)</sup> Adjust  $V_{CC}$  above the start threshold before setting it to 15 V.

<sup>(2)</sup> All typical values are at  $T_J = 25$ °C.

<sup>(2)</sup> All typical values are at T<sub>J</sub> = 25°C.

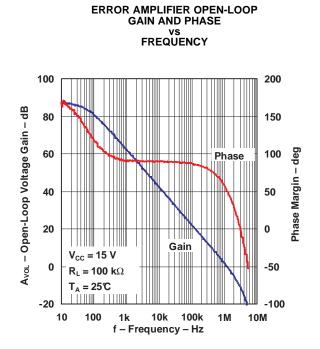
<sup>(2)</sup> All typical values are at  $T_J = 25$ °C.

<sup>(2)</sup> All typical values are at  $T_J = 25^{\circ}$ C.



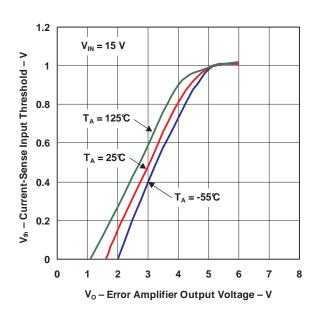
### TYPICAL CHARACTERISTICS

SUPPLY CURRENT vs SUPPLY VOLTAGE 25 20 Icc - Supply Current - mA 15 10 TL2842 TL2845 5 0 0 5 15 20 25 30 35 40 10

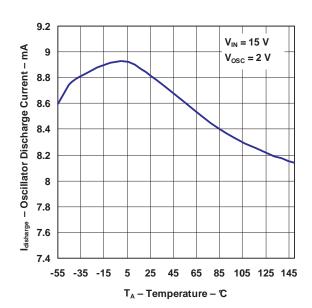


# CURRENT-SENSE INPUT THRESHOLD VS ERROR AMPLIFIER OUTPUT VOLTAGE

V<sub>cc</sub> - Supply Voltage - V

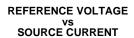


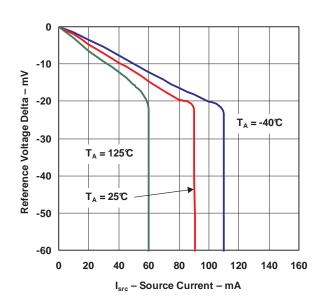
# OSCILLATOR DISCHARGE CURRENT vs TEMPERATURE



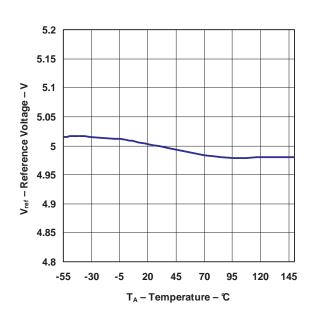
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# **TYPICAL CHARACTERISTICS (continued)**

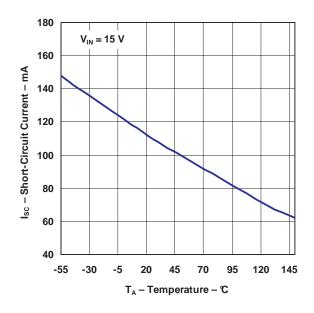




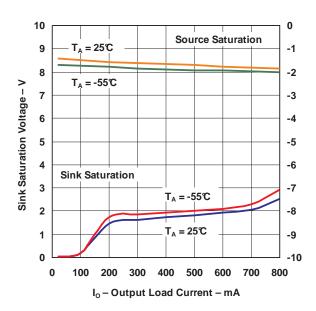
# REFERENCE VOLTAGE vs TEMPERATURE



# REFERENCE SHORT-CIRCUIT CURRENT vs TEMPERATURE



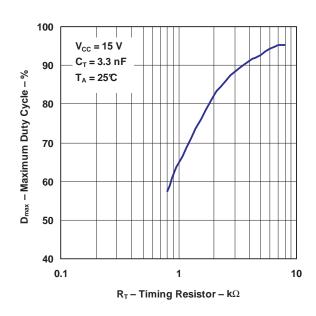
# OUTPUT SATURATION VOLTAGE VS LOAD CURRENT

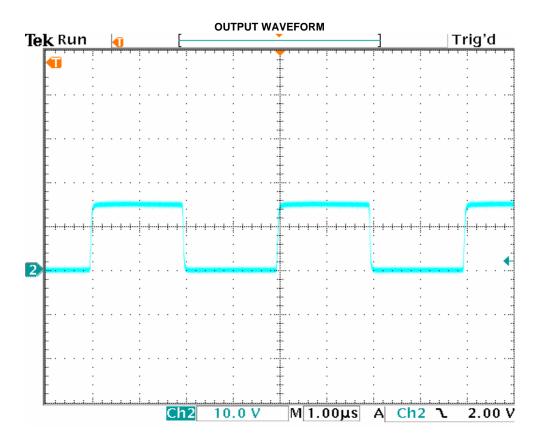




# **TYPICAL CHARACTERISTICS (continued)**

# MAXIMUM OUTPUT DUTY CYCLE vs TIMING RESISTOR

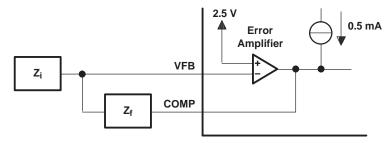




SLVS610B-AUGUST 2006-REVISED JULY 2007

# **APPLICATION INFORMATION**

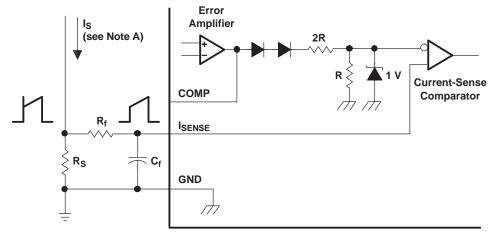
The error-amplifier configuation circuit is shown in Figure 1.



A. Error amplifier can source or sink up to 0.5 mA.

Figure 1. Error-Amplifier Configuration

The current-sense circuit is shown in Figure 2.



- A. Peak current ( $I_S$ ) is determined by the formula:  $I_{S(max)} = 1 \text{ V/R}_S$
- B. A small RC filter formed by resistor  $R_f$  and capacitor  $C_f$  may be required to suppress switch transients.

Figure 2. Current-Sense Circuit

The oscillator frequency is set using the circuit shown in Figure 3. The frequency is calculated as:

$$f = 1 / R_T C_T$$

For  $R_T > 5 \text{ k}\Omega$ :

$$f \approx 1.72 / R_T C_T$$

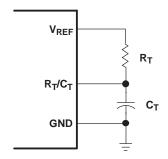
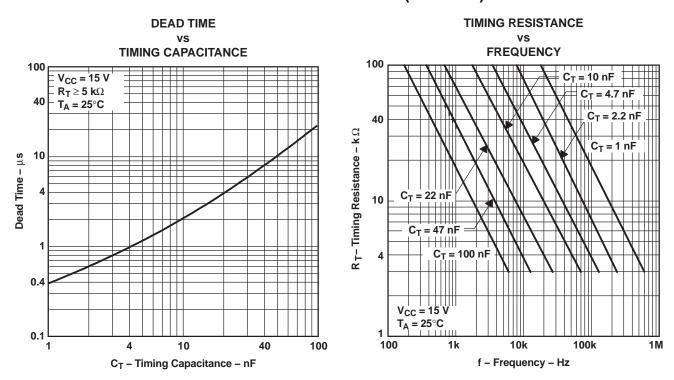


Figure 3. Oscillator Section



### **APPLICATION INFORMATION (continued)**



# **Open-Loop Laboratory Test Fixture**

In the open-loop laboratory test fixture (see Figure 4), high peak currents associated with loads necessitate careful grounding techniques. Timing and bypass capacitors should be connected close to the GND terminal in a single-point ground. The transistor and 5-k $\Omega$  potentiometer sample the oscillator waveform and apply an adjustable ramp to the  $I_{SENSE}$  terminal.

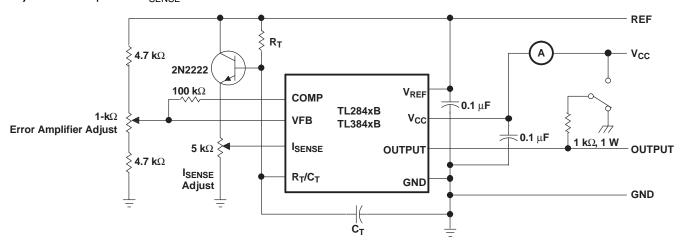


Figure 4. Open-Loop Laboratory Test Fixture

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# **APPLICATION INFORMATION (continued)**

#### **Shutdown Technique**

The PWM controller (see Figure 5) can be shut down by two methods: either raise the voltage at  $I_{SENSE}$  above 1 V or pull the COMP terminal below a voltage two diode drops above ground. Either method causes the output of the PWM comparator to be high (refer to block diagram). The PWM latch is reset dominant so that the output remains low until the next clock cycle after the shutdown condition at the COMP or  $I_{SENSE}$  terminal is removed. In one example, an externally latched shutdown can be accomplished by adding an SCR that resets by cycling  $V_{CC}$  below the lower UVLO threshold. At this point, the reference turns off, allowing the SCR to reset.

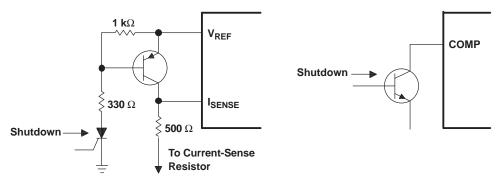


Figure 5. Shutdown Techniques

A fraction of the oscillator ramp can be summed resistively with the current-sense signal to provide slope compensation for converters requiring duty cycles over 50% (see Figure 6). Note that capacitor C forms a filter with R2 to suppress the leading-edge switch spikes.

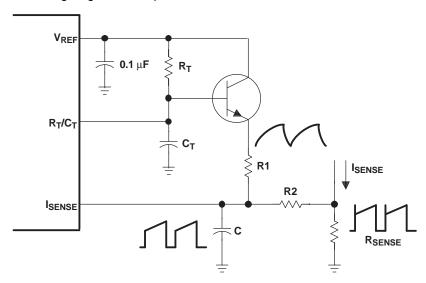


Figure 6. Slope Compensation





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# **PACKAGING INFORMATION**

| Orderable Device | Status | Package Type | Package<br>Drawing | Pins | Package<br>Qty | Eco Plan                   | Lead/Ball Finish | MSL Peak Temp      | Op Temp (°C) | Device Marking (4/5) | Samples |
|------------------|--------|--------------|--------------------|------|----------------|----------------------------|------------------|--------------------|--------------|----------------------|---------|
| TL2842BD         | ACTIVE | SOIC         | D                  | 14   | 50             | Green (RoHS<br>& no Sb/Br) | CU NIPDAU        | Level-1-260C-UNLIM | -40 to 85    | TL2842B              | Samples |
| TL2842BD-8       | ACTIVE | SOIC         | D                  | 8    | 75             | Green (RoHS<br>& no Sb/Br) | CU NIPDAU        | Level-1-260C-UNLIM | -40 to 85    | 2842B                | Samples |
| TL2842BDR        | ACTIVE | SOIC         | D                  | 14   | 2500           | Green (RoHS<br>& no Sb/Br) | CU NIPDAU        | Level-1-260C-UNLIM | -40 to 85    | TL2842B              | Samples |
| TL2842BDR-8      | ACTIVE | SOIC         | D                  | 8    | 2500           | Green (RoHS<br>& no Sb/Br) | CU NIPDAU        | Level-1-260C-UNLIM | -40 to 85    | 2842B                | Samples |
| TL2842BP         | ACTIVE | PDIP         | Р                  | 8    | 50             | Pb-Free<br>(RoHS)          | CU NIPDAU        | N / A for Pkg Type | -40 to 85    | TL2842BP             | Samples |
| TL2843BD         | ACTIVE | SOIC         | D                  | 14   | 50             | Green (RoHS<br>& no Sb/Br) | CU NIPDAU        | Level-1-260C-UNLIM | -40 to 85    | TL2843B              | Samples |
| TL2843BD-8       | ACTIVE | SOIC         | D                  | 8    | 75             | Green (RoHS<br>& no Sb/Br) | CU NIPDAU        | Level-1-260C-UNLIM | -40 to 85    | 2843B                | Samples |
| TL2843BDR        | ACTIVE | SOIC         | D                  | 14   | 2500           | Green (RoHS<br>& no Sb/Br) | CU NIPDAU        | Level-1-260C-UNLIM | -40 to 85    | TL2843B              | Samples |
| TL2843BDR-8      | ACTIVE | SOIC         | D                  | 8    | 2500           | Green (RoHS<br>& no Sb/Br) | CU NIPDAU        | Level-1-260C-UNLIM | -40 to 85    | 2843B                | Samples |
| TL2843BDRG4-8    | ACTIVE | SOIC         | D                  | 8    | 2500           | Green (RoHS<br>& no Sb/Br) | CU NIPDAU        | Level-1-260C-UNLIM | -40 to 85    | 2843B                | Samples |
| TL2843BP         | ACTIVE | PDIP         | Р                  | 8    | 50             | Pb-Free<br>(RoHS)          | CU NIPDAU        | N / A for Pkg Type | -40 to 85    | TL2843BP             | Samples |
| TL2843BPG4       | ACTIVE | PDIP         | Р                  | 8    |                | TBD                        | Call TI          | Call TI            | -40 to 85    |                      | Samples |
| TL2844BD-8       | ACTIVE | SOIC         | D                  | 8    | 75             | Green (RoHS<br>& no Sb/Br) | CU NIPDAU        | Level-1-260C-UNLIM | -40 to 85    | 2844B                | Samples |
| TL2844BDR        | ACTIVE | SOIC         | D                  | 14   | 2500           | Green (RoHS<br>& no Sb/Br) | CU NIPDAU        | Level-1-260C-UNLIM | -40 to 85    | TL2844B              | Samples |
| TL2844BDR-8      | ACTIVE | SOIC         | D                  | 8    | 2500           | Green (RoHS<br>& no Sb/Br) | CU NIPDAU        | Level-1-260C-UNLIM | -40 to 85    | 2844B                | Samples |
| TL2844BDRG4-8    | ACTIVE | SOIC         | D                  | 8    | 2500           | Green (RoHS<br>& no Sb/Br) | CU NIPDAU        | Level-1-260C-UNLIM | -40 to 85    | 2844B                | Samples |
| TL2845BD         | ACTIVE | SOIC         | D                  | 14   | 50             | Green (RoHS<br>& no Sb/Br) | CU NIPDAU        | Level-1-260C-UNLIM | -40 to 85    | TL2845B              | Samples |



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| Orderable Device | Status | Package Type | Package<br>Drawing | Pins | Package<br>Qty | Eco Plan                   | Lead/Ball Finish | MSL Peak Temp                | Op Temp (°C) | Device Marking (4/5) | Samples |
|------------------|--------|--------------|--------------------|------|----------------|----------------------------|------------------|------------------------------|--------------|----------------------|---------|
| TL2845BD-8       | ACTIVE | SOIC         | D                  | 8    | 75             | Green (RoHS<br>& no Sb/Br) | CU NIPDAU        | Level-1-260C-UNLIM           | -40 to 85    | 2845B                |         |
| TL2845BDR        | ACTIVE | SOIC         | D                  | 14   | 2500           | Green (RoHS<br>& no Sb/Br) | CU NIPDAU        | Level-1-260C-UNLIM -40 to 85 |              | TL2845B              | Samples |
| TL2845BDR-8      | ACTIVE | SOIC         | D                  | 8    | 2500           | Green (RoHS<br>& no Sb/Br) | CU NIPDAU        | Level-1-260C-UNLIM -40 to 85 |              | 2845B                | Samples |
| TL2845BDRG4-8    | ACTIVE | SOIC         | D                  | 8    | 2500           | Green (RoHS<br>& no Sb/Br) | CU NIPDAU        | Level-1-260C-UNLIM -40 to 85 |              | 2845B                | Samples |
| TL2845BP         | ACTIVE | PDIP         | Р                  | 8    | 50             | Pb-Free<br>(RoHS)          | CU NIPDAU        | N / A for Pkg Type           | -40 to 85    | TL2845BP             | Samples |
| TL3842BD         | ACTIVE | SOIC         | D                  | 14   | 50             | Green (RoHS<br>& no Sb/Br) | CU NIPDAU        | Level-1-260C-UNLIM           | 0 to 70      | TL3842B              | Samples |
| TL3842BD-8       | ACTIVE | SOIC         | D                  | 8    | 75             | Green (RoHS<br>& no Sb/Br) | CU NIPDAU        | Level-1-260C-UNLIM 0 to 70   |              | 3842B                | Samples |
| TL3842BDR        | ACTIVE | SOIC         | D                  | 14   | 2500           | Green (RoHS<br>& no Sb/Br) | CU NIPDAU        | Level-1-260C-UNLIM 0 to 70   |              | TL3842B              | Samples |
| TL3842BDR-8      | ACTIVE | SOIC         | D                  | 8    | 2500           | Green (RoHS<br>& no Sb/Br) | CU NIPDAU        | Level-1-260C-UNLIM 0 to 70   |              | 3842B                | Samples |
| TL3842BP         | ACTIVE | PDIP         | Р                  | 8    | 50             | Pb-Free<br>(RoHS)          | CU NIPDAU        | N / A for Pkg Type 0 to 70   |              | TL3842BP             | Samples |
| TL3842BPE4       | ACTIVE | PDIP         | Р                  | 8    | 50             | Pb-Free<br>(RoHS)          | CU NIPDAU        | N / A for Pkg Type           | 0 to 70      | TL3842BP             | Samples |
| TL3843BD         | ACTIVE | SOIC         | D                  | 14   | 50             | Green (RoHS<br>& no Sb/Br) | CU NIPDAU        | Level-1-260C-UNLIM           | 0 to 70      | TL3843B              | Samples |
| TL3843BD-8       | ACTIVE | SOIC         | D                  | 8    | 75             | Green (RoHS<br>& no Sb/Br) | CU NIPDAU        | Level-1-260C-UNLIM           | 0 to 70      | 3843B                | Samples |
| TL3843BDR        | ACTIVE | SOIC         | D                  | 14   | 2500           | Green (RoHS<br>& no Sb/Br) | CU NIPDAU        | Level-1-260C-UNLIM           | 0 to 70      | TL3843B              | Samples |
| TL3843BDR-8      | ACTIVE | SOIC         | D                  | 8    | 2500           | Green (RoHS<br>& no Sb/Br) | CU NIPDAU        | Level-1-260C-UNLIM 0 to 70   |              | 3843B                | Samples |
| TL3843BDRG4      | ACTIVE | SOIC         | D                  | 14   | 2500           | Green (RoHS<br>& no Sb/Br) | CU NIPDAU        | Level-1-260C-UNLIM 0 to 70   |              | TL3843B              | Samples |
| TL3843BP         | ACTIVE | PDIP         | Р                  | 8    | 50             | Pb-Free<br>(RoHS)          | CU NIPDAU        | N / A for Pkg Type           | 0 to 70      | TL3843BP             | Samples |
| TL3843BPE4       | ACTIVE | PDIP         | Р                  | 8    | 50             | Pb-Free<br>(RoHS)          | CU NIPDAU        | N / A for Pkg Type           | 0 to 70      | TL3843BP             | Samples |



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# PACKAGE OPTION ADDENDUM

24-Aug-2014

| Orderable Device | Status | Package Type | _       | Pins | _    | Eco Plan                   | Lead/Ball Finish | MSL Peak Temp      | Op Temp (°C) | <b>Device Marking</b> | Samples |
|------------------|--------|--------------|---------|------|------|----------------------------|------------------|--------------------|--------------|-----------------------|---------|
|                  | (1)    |              | Drawing |      | Qty  | (2)                        | (6)              | (3)                |              | (4/5)                 |         |
| TL3844BD-8       | ACTIVE | SOIC         | D       | 8    | 75   | Green (RoHS<br>& no Sb/Br) | CU NIPDAU        | Level-1-260C-UNLIM | 0 to 70      | 3844B                 | Samples |
| TL3844BDR        | ACTIVE | SOIC         | D       | 14   | 2500 | Green (RoHS<br>& no Sb/Br) | CU NIPDAU        | Level-1-260C-UNLIM | 0 to 70      | TL3844B               | Samples |
| TL3844BDR-8      | ACTIVE | SOIC         | D       | 8    | 2500 | Green (RoHS<br>& no Sb/Br) | CU NIPDAU        | Level-1-260C-UNLIM | 0 to 70      | 3844B                 | Samples |
| TL3844BP         | ACTIVE | PDIP         | Р       | 8    | 50   | Pb-Free<br>(RoHS)          | CU NIPDAU        | N / A for Pkg Type | 0 to 70      | TL3844BP              | Samples |
| TL3844BPE4       | ACTIVE | PDIP         | Р       | 8    | 50   | Pb-Free<br>(RoHS)          | CU NIPDAU        | N / A for Pkg Type | 0 to 70      | TL3844BP              | Samples |
| TL3845BD         | ACTIVE | SOIC         | D       | 14   | 50   | Green (RoHS<br>& no Sb/Br) | CU NIPDAU        | Level-1-260C-UNLIM | 0 to 70      | TL3845B               | Samples |
| TL3845BD-8       | ACTIVE | SOIC         | D       | 8    | 75   | Green (RoHS<br>& no Sb/Br) | CU NIPDAU        | Level-1-260C-UNLIM | 0 to 70      | 3845B                 | Samples |
| TL3845BDG4-8     | ACTIVE | SOIC         | D       | 8    | 75   | Green (RoHS<br>& no Sb/Br) | CU NIPDAU        | Level-1-260C-UNLIM | 0 to 70      | 3845B                 | Samples |
| TL3845BDR        | ACTIVE | SOIC         | D       | 14   | 2500 | Green (RoHS<br>& no Sb/Br) | CU NIPDAU        | Level-1-260C-UNLIM | 0 to 70      | TL3845B               | Samples |
| TL3845BDR-8      | ACTIVE | SOIC         | D       | 8    | 2500 | Green (RoHS<br>& no Sb/Br) | CU NIPDAU        | Level-1-260C-UNLIM | 0 to 70      | 3845B                 | Samples |
| TL3845BP         | ACTIVE | PDIP         | Р       | 8    | 50   | Pb-Free<br>(RoHS)          | CU NIPDAU        | N / A for Pkg Type | 0 to 70      | TL3845BP              | Samples |

(1) The marketing status values are defined as follows:

**ACTIVE:** Product device recommended for new designs.

LIFEBUY: TI has announced that the device will be discontinued, and a lifetime-buy period is in effect.

NRND: Not recommended for new designs. Device is in production to support existing customers, but TI does not recommend using this part in a new design.

PREVIEW: Device has been announced but is not in production. Samples may or may not be available.

**OBSOLETE:** TI has discontinued the production of the device.

TBD: The Pb-Free/Green conversion plan has not been defined.

**Pb-Free** (RoHS): TI's terms "Lead-Free" or "Pb-Free" mean semiconductor products that are compatible with the current RoHS requirements for all 6 substances, including the requirement that lead not exceed 0.1% by weight in homogeneous materials. Where designed to be soldered at high temperatures, TI Pb-Free products are suitable for use in specified lead-free processes. **Pb-Free** (RoHS Exempt): This component has a RoHS exemption for either 1) lead-based flip-chip solder bumps used between the die and package, or 2) lead-based die adhesive used between

the die and leadframe. The component is otherwise considered Pb-Free (RoHS compatible) as defined above.

<sup>(2)</sup> Eco Plan - The planned eco-friendly classification: Pb-Free (RoHS), Pb-Free (RoHS Exempt), or Green (RoHS & no Sb/Br) - please check http://www.ti.com/productcontent for the latest availability information and additional product content details.



# PACKAGE OPTION ADDENDUM

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Green (RoHS & no Sb/Br): TI defines "Green" to mean Pb-Free (RoHS compatible), and free of Bromine (Br) and Antimony (Sb) based flame retardants (Br or Sb do not exceed 0.1% by weight in homogeneous material)

- (3) MSL, Peak Temp. The Moisture Sensitivity Level rating according to the JEDEC industry standard classifications, and peak solder temperature.
- (4) There may be additional marking, which relates to the logo, the lot trace code information, or the environmental category on the device.
- (5) Multiple Device Markings will be inside parentheses. Only one Device Marking contained in parentheses and separated by a "~" will appear on a device. If a line is indented then it is a continuation of the previous line and the two combined represent the entire Device Marking for that device.
- (6) Lead/Ball Finish Orderable Devices may have multiple material finish options. Finish options are separated by a vertical ruled line. Lead/Ball Finish values may wrap to two lines if the finish value exceeds the maximum column width.

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#### OTHER QUALIFIED VERSIONS OF TL2843B:

Automotive: TL2843B-Q1

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NOTE: Qualified Version Definitions:

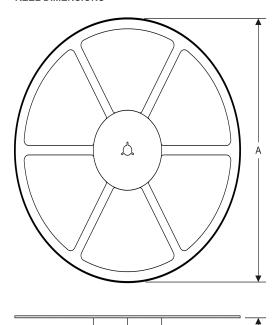
Automotive - Q100 devices qualified for high-reliability automotive applications targeting zero defects

# PACKAGE MATERIALS INFORMATION

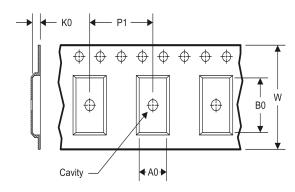
www.ti.com 14-Jul-2012

# TAPE AND REEL INFORMATION

### **REEL DIMENSIONS**



# TAPE DIMENSIONS



| A0 | Dimension designed to accommodate the component width     |
|----|---|
| В0 | Dimension designed to accommodate the component length    |
| K0 | Dimension designed to accommodate the component thickness |
| W  | Overall width of the carrier tape                         |
| P1 | Pitch between successive cavity centers                   |

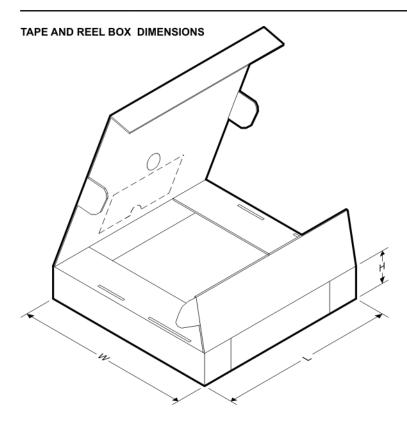
## TAPE AND REEL INFORMATION

### \*All dimensions are nominal

| Device      | Package<br>Type | Package<br>Drawing |    | SPQ  | Reel<br>Diameter<br>(mm) | Reel<br>Width<br>W1 (mm) | A0<br>(mm) | B0<br>(mm) | K0<br>(mm) | P1<br>(mm) | W<br>(mm) | Pin1<br>Quadrant |
|-------------|-----------------|--------------------|----|------|--------------------------|--------------------------|------------|------------|------------|------------|-----------|------------------|
| TL2842BDR   | SOIC            | D                  | 14 | 2500 | 330.0                    | 16.4                     | 6.5        | 9.0        | 2.1        | 8.0        | 16.0      | Q1               |
| TL2842BDR-8 | SOIC            | D                  | 8  | 2500 | 330.0                    | 12.4                     | 6.4        | 5.2        | 2.1        | 8.0        | 12.0      | Q1               |
| TL2843BDR   | SOIC            | D                  | 14 | 2500 | 330.0                    | 16.4                     | 6.5        | 9.0        | 2.1        | 8.0        | 16.0      | Q1               |
| TL2843BDR-8 | SOIC            | D                  | 8  | 2500 | 330.0                    | 12.4                     | 6.4        | 5.2        | 2.1        | 8.0        | 12.0      | Q1               |
| TL2844BDR   | SOIC            | D                  | 14 | 2500 | 330.0                    | 16.4                     | 6.5        | 9.0        | 2.1        | 8.0        | 16.0      | Q1               |
| TL2844BDR-8 | SOIC            | D                  | 8  | 2500 | 330.0                    | 12.4                     | 6.4        | 5.2        | 2.1        | 8.0        | 12.0      | Q1               |
| TL2845BDR   | SOIC            | D                  | 14 | 2500 | 330.0                    | 16.4                     | 6.5        | 9.0        | 2.1        | 8.0        | 16.0      | Q1               |
| TL2845BDR-8 | SOIC            | D                  | 8  | 2500 | 330.0                    | 12.4                     | 6.4        | 5.2        | 2.1        | 8.0        | 12.0      | Q1               |
| TL3842BDR   | SOIC            | D                  | 14 | 2500 | 330.0                    | 16.4                     | 6.5        | 9.0        | 2.1        | 8.0        | 16.0      | Q1               |
| TL3842BDR-8 | SOIC            | D                  | 8  | 2500 | 330.0                    | 12.4                     | 6.4        | 5.2        | 2.1        | 8.0        | 12.0      | Q1               |
| TL3843BDR   | SOIC            | D                  | 14 | 2500 | 330.0                    | 16.4                     | 6.5        | 9.0        | 2.1        | 8.0        | 16.0      | Q1               |
| TL3843BDR-8 | SOIC            | D                  | 8  | 2500 | 330.0                    | 12.4                     | 6.4        | 5.2        | 2.1        | 8.0        | 12.0      | Q1               |
| TL3844BDR   | SOIC            | D                  | 14 | 2500 | 330.0                    | 16.4                     | 6.5        | 9.0        | 2.1        | 8.0        | 16.0      | Q1               |
| TL3844BDR-8 | SOIC            | D                  | 8  | 2500 | 330.0                    | 12.4                     | 6.4        | 5.2        | 2.1        | 8.0        | 12.0      | Q1               |
| TL3845BDR   | SOIC            | D                  | 14 | 2500 | 330.0                    | 16.4                     | 6.5        | 9.0        | 2.1        | 8.0        | 16.0      | Q1               |
| TL3845BDR-8 | SOIC            | D                  | 8  | 2500 | 330.0                    | 12.4                     | 6.4        | 5.2        | 2.1        | 8.0        | 12.0      | Q1               |

**PACKAGE MATERIALS INFORMATION** 

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\*All dimensions are nominal

| Device      | Package Type | Package Drawing | Pins | SPQ  | Length (mm) | Width (mm) | Height (mm) |
|-------------|--------------|-----------------|------|------|-------------|------------|-------------|
| TL2842BDR   | SOIC         | D               | 14   | 2500 | 367.0       | 367.0      | 38.0        |
| TL2842BDR-8 | SOIC         | D               | 8    | 2500 | 340.5       | 338.1      | 20.6        |
| TL2843BDR   | SOIC         | D               | 14   | 2500 | 367.0       | 367.0      | 38.0        |
| TL2843BDR-8 | SOIC         | D               | 8    | 2500 | 340.5       | 338.1      | 20.6        |
| TL2844BDR   | SOIC         | D               | 14   | 2500 | 367.0       | 367.0      | 38.0        |
| TL2844BDR-8 | SOIC         | D               | 8    | 2500 | 340.5       | 338.1      | 20.6        |
| TL2845BDR   | SOIC         | D               | 14   | 2500 | 367.0       | 367.0      | 38.0        |
| TL2845BDR-8 | SOIC         | D               | 8    | 2500 | 340.5       | 338.1      | 20.6        |
| TL3842BDR   | SOIC         | D               | 14   | 2500 | 367.0       | 367.0      | 38.0        |
| TL3842BDR-8 | SOIC         | D               | 8    | 2500 | 340.5       | 338.1      | 20.6        |
| TL3843BDR   | SOIC         | D               | 14   | 2500 | 367.0       | 367.0      | 38.0        |
| TL3843BDR-8 | SOIC         | D               | 8    | 2500 | 340.5       | 338.1      | 20.6        |
| TL3844BDR   | SOIC         | D               | 14   | 2500 | 367.0       | 367.0      | 38.0        |
| TL3844BDR-8 | SOIC         | D               | 8    | 2500 | 340.5       | 338.1      | 20.6        |
| TL3845BDR   | SOIC         | D               | 14   | 2500 | 367.0       | 367.0      | 38.0        |
| TL3845BDR-8 | SOIC         | D               | 8    | 2500 | 340.5       | 338.1      | 20.6        |

# P (R-PDIP-T8)

# PLASTIC DUAL-IN-LINE PACKAGE



- A. All linear dimensions are in inches (millimeters).
- B. This drawing is subject to change without notice.
- C. Falls within JEDEC MS-001 variation BA.



# D (R-PDSO-G14)

# PLASTIC SMALL OUTLINE



- A. All linear dimensions are in inches (millimeters).
- B. This drawing is subject to change without notice.
- Body length does not include mold flash, protrusions, or gate burrs. Mold flash, protrusions, or gate burrs shall not exceed 0.006 (0,15) each side.
- Body width does not include interlead flash. Interlead flash shall not exceed 0.017 (0,43) each side.
- E. Reference JEDEC MS-012 variation AB.



# D (R-PDSO-G14)

# PLASTIC SMALL OUTLINE



- A. All linear dimensions are in millimeters.
- B. This drawing is subject to change without notice.
- C. Publication IPC-7351 is recommended for alternate designs.
- D. Laser cutting apertures with trapezoidal walls and also rounding corners will offer better paste release. Customers should contact their board assembly site for stencil design recommendations. Refer to IPC-7525 for other stencil recommendations.
- E. Customers should contact their board fabrication site for solder mask tolerances between and around signal pads.



# D (R-PDSO-G8)

# PLASTIC SMALL OUTLINE



- A. All linear dimensions are in inches (millimeters).
- B. This drawing is subject to change without notice.
- Body length does not include mold flash, protrusions, or gate burrs. Mold flash, protrusions, or gate burrs shall not exceed 0.006 (0,15) each side.
- Body width does not include interlead flash. Interlead flash shall not exceed 0.017 (0,43) each side.
- E. Reference JEDEC MS-012 variation AA.



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